General Description

The SN74HC/HCT365 is a hex buffer/line driver with 3-state outputs controlled by the output enable inputs ($\overline{OE}n$). A HIGH on $\overline{OE}n$ causes the outputs to assume a high impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features

- Input levels:
  For SN74HC365: CMOS level
  For SN74HCT365: TTL level
- 3-state outputs
- Specified from -40℃ to +125℃
- Packaging information: DIP16/SOP16/TSSOP16

Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW SN74HC365N	DIP-16	74HC365N	Tube	1000Pcs/Box
XBLW SN74HC365DTR	SOP-16	74HC365	Tape	2500Pcs/Reel
XBLW SN74HC365TDTR	TSSOP-16	74HC365	Tape	3000Pcs/Reel
XBLW SN74HCT365N	DIP-16	74HCT365N	Tube	1000Pcs/Box
XBLW SN74HCT365DTR	SOP-16	74HCT365	Tape	2500Pcs/Reel
XBLW SN74HCT365TDTR	TSSOP-16	74HCT365	Tape	3000Pcs/Reel

Block Diagram And Pin Description

Block Diagram

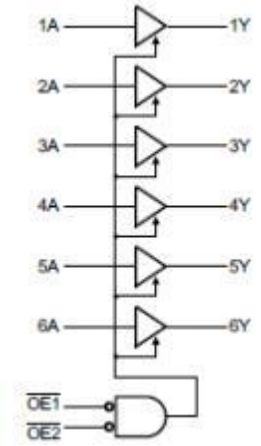


Figure 1. Logic symbol

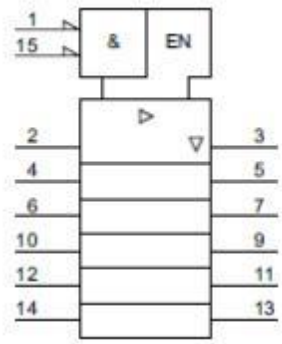


Figure 2. IEC logic symbol

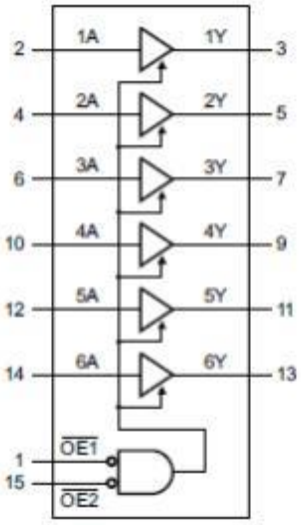


Figure 3. Functional diagram

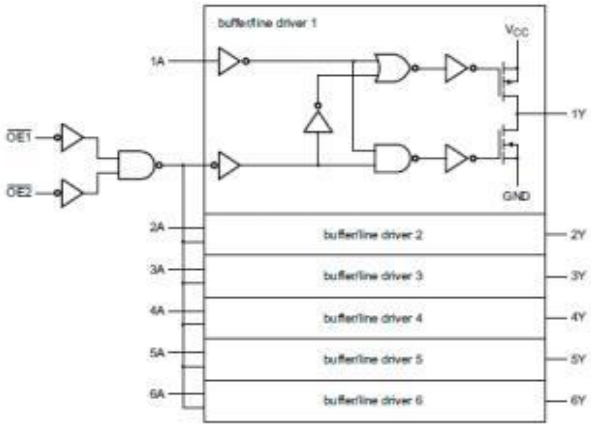
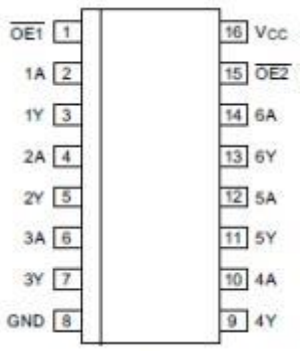


Figure 4. Logic diagram

Pin Configurations



Pin DescriptionFunction Table

Pin No.	Pin Name	Description
1	$\overline{OE}1$	output enable input 1 (active LOW)
2	1A	data input 1
3	1Y	data output 1
4	2A	data input 2
5	2Y	data output 2
6	3A	data input 3
7	3Y	data output 3
8	GND	ground (0V)
9	4Y	data output 4
10	4A	data input 4
11	5Y	data output 5
12	5A	data input 5
13	6Y	data output 6
14	6A	data input 6
15	$\overline{OE}2$	output enable input 2 (active LOW)
16	V_{CC}	supply voltage

Function Table

Input			Output
$\overline{OE}1$	$\overline{OE}2$	nA	nY
L	L	L	L
L	L	H	H
X	H	X	Z
H	X	X	Z

Note：H=HIGH voltage level; L=LOW voltage level; X=don’tcare; Z=high-impedance OFF-state.

Electrical Parameter

Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Max.	Unit
supply voltage	V_{CC}	-		-0.5	+7.0	V
input clamping current	I_{IK}	V_I < -0.5V or V_I > V_{CC}+0.5V		-	±20	mA
output clamping current	I_{OK}	V_O < -0.5V or V_O > V_{CC}+0.5V		-	±20	mA
output current	I_O	-0.5V < V_O < V_{CC}+0.5V		-	±35	mA
supply current	I_{CC}	-		-	70	mA
ground current	I_{GND}	-		-70	-	mA
storage temperature	T_{stg}	-		-65	+150	℃
total power dissipation	P_{tot}	-		-	500	mW
Soldering temperature	T_L	10s	DIP	245		℃
			SOP/TSSOP	260		

Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
SN74HC365						
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	V_{CC}=2.0V	-	-	625	ns/V
		V_{CC}=4.5V	-	1.67	139	ns/V
		V_{CC}=6.0V	-	-	83	ns/V
ambient temperature	T_{amb}	-	-40	-	+125	℃
SN74HCT365						
supply voltage	V_{CC}	-	4.5	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	V_{CC}=4.5V	-	1.67	139	ns/V
ambient temperature	T_{amb}	-	-40	-	+125	℃

DC Characteristics 1

(T_{amb}=25℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	1.2	-	V
		V_{CC}=4.5V		3.15	2.4	-	V
		V_{CC}=6.0V		4.2	3.2	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	0.8	0.5	V
		V_{CC}=4.5V		-	2.1	1.35	V
		V_{CC}=6.0V		-	2.8	1.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	2.0	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	4.5	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	6.0	-	V
			I_O=-6.0mA; V_{CC}=4.5V	3.98	4.32	-	V
			I_O=-7.8mA; V_{CC}=6.0V	5.48	5.81	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	0	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	0	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	0	0.1	V
			I_O=6.0mA; V_{CC}=4.5V	-	0.15	0.26	V
			I_O=7.8mA; V_{CC}=6.0V	-	0.16	0.26	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=6.0V; V_O=V_{CC} or GND		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	8.0	uA

input capacitance	C_I	-		-	3.5	-	pF
SN74HCT365							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	1.6	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	1.2	0.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	4.5	-	V
			I_O=-6.0mA	3.98	4.32	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	0	0.1	V
			I_O=6.0mA	-	0.16	0.26	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=5.5V; V_O=V_{CC} or GND		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	8.0	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A	pins nA	-	-	360	uA
			pin $\overline{OE}$1	-	-	360	uA
			pin $\overline{OE}$2	-	-	324	uA
input capacitance	C_I	-		-	3.5	-	pF

DC Characteristics 2

(T_{amb}=-40℃ to +85℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	-	-	V
		V_{CC}=4.5V		3.15	-	-	V
		V_{CC}=6.0V		4.2	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	-	0.5	V
		V_{CC}=4.5V		-	-	1.35	V
		V_{CC}=6.0V		-	-	1.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	-	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	-	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	-	-	V
			I_O=-6.0mA; V_{CC}=4.5V	3.84	-	-	V
			I_O=-7.8mA; V_{CC}=6.0V	5.34	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	-	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	-	0.1	V
			I_O=6.0mA; V_{CC}=4.5V	-	-	0.33	V
			I_O=7.8mA; V_{CC}=6.0V	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=6.0V; V_O=V_{CC} or GND		-	-	±5.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	80	uA

SN74HCT365							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	-	0.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	-	-	V
			I_O=-6.0mA	3.84	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	-	0.1	V
			I_O=6.0mA	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=5.5V; V_O=V_{CC} or GND		-	-	±5.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	80	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A	pins nA	-	-	450	uA
			pin $\overline{OE}$1	-	-	450	uA
			pin $\overline{OE}$2	-	-	405	uA

DC Characteristics 3

(T_{amb}=-40℃ to +125℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	-	-	V
		V_{CC}=4.5V		3.15	-	-	V
		V_{CC}=6.0V		4.2	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	-	0.5	V
		V_{CC}=4.5V		-	-	1.35	V
		V_{CC}=6.0V		-	-	1.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	-	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	-	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	-	-	V
			I_O=-6.0mA; V_{CC}=4.5V	3.7	-	-	V
			I_O=-7.8mA; V_{CC}=6.0V	5.2	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	-	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	-	0.1	V
			I_O=6.0mA; V_{CC}=4.5V	-	-	0.4	V
			I_O=7.8mA; V_{CC}=6.0V	-	-	0.4	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=6.0V; V_O=V_{CC} or GND		-	-	±10	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	160	uA
SN74HCT365							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	-	-	V
LOW-level	V_{IL}	V_{CC}=4.5V to 5.5V		-	-	0.8	V

input voltage							
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	-	-	V
			I_O=-6.0mA	3.7	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	-	0.1	V
			I_O=6.0mA	-	-	0.4	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
OFF-state output current	I_{OZ}	V_I=V_{IH} orV_{IL}; V_{CC}=5.5V; V_O=V_{CC} or GND		-	-	±10	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	160	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A	pins nA	-	-	490	uA
			pin $\overline{OE}$1	-	-	490	uA
			pin $\overline{OE}$2	-	-	441	uA

AC Characteristics 1

(T_{amb}=25℃, GND =0V, C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=2.0V	-	30	95	ns
			V_{CC}=4.5V	-	11	19	ns
			V_{CC}=5.0V; C_L=15pF	-	9	-	ns
			V_{CC}=6.0V	-	9	16	ns
$\overline{OE}$n to nY enable time	t_{en}	see Figure 7	V_{CC}=2.0V	-	47	150	ns
			V_{CC}=4.5V	-	17	30	ns
			V_{CC}=6.0V	-	14	26	ns
$\overline{OE}$n to nY disable time	t_{dis}	see Figure 7	V_{CC}=2.0V	-	61	150	ns
			V_{CC}=4.5V	-	22	30	ns
			V_{CC}=6.0V	-	18	26	ns
transition time	t_t	see Figure 6	V_{CC}=2.0V	-	14	60	ns
			V_{CC}=4.5V	-	5	12	ns
			V_{CC}=6.0V	-	4	10	ns
power dissipation capacitance	C_{PD}	per buffer; V_I=GND to V_{CC}		-	40	-	pF
SN74HCT365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=4.5V	-	14	25	ns
			V_{CC}=5.0V; C_L=15pF	-	11	-	ns
$\overline{OE}$n to nY enable time	t_{en}	V_{CC}=4.5V; see Figure 7		-	18	35	ns
$\overline{OE}$n to nY disable time	t_{dis}	V_{CC}=4.5V; see Figure 7		-	23	35	ns
transition time	t_t	V_{CC}=4.5V; see Figure 6		-	5	12	ns
power dissipation capacitance	C_{PD}	per buffer; V_I=GND to V_{CC}-1.5V		-	40	-	pF

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_{en} is the same as t_{PZL} and t_{PZH}.

[3] t_{dis} is the sameast$_{PLZ}$ and t_{PHZ}.

[4] t_t is the sameast$_{THL}$ and t_{TLH}.

[5] C_{PD} isused to determine the dynamic power dissipation (P_D in uW).

$P_D=C_{PD}\times V_{CC}^2\times f_i\times N+\Sigma(C_L\times V_{CC}^2\times f_o)$ where:

f_i=input frequency in MHz;

f_o=output frequency in MHz;

C_L=output load capacitance in pF;

V_{CC}=supply voltage in V;

N=number of inputs switching;

$\Sigma(C_L\times V_{CC}^2\times f_o)$=sum of outputs.

AC Characteristics 2

(T_{amb}=-40℃ to +85℃, GND=0V, C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=2.0V	-	-	120	ns
			V_{CC}=4.5V	-	-	24	ns
			V_{CC}=6.0V	-	-	20	ns
$\overline{OE}$n to nY enable time	t_{en}	see Figure 7	V_{CC}=2.0V	-	-	190	ns
			V_{CC}=4.5V	-	-	38	ns
			V_{CC}=6.0V	-	-	33	ns
$\overline{OE}$n to nY disable time	t_{dis}	see Figure 7	V_{CC}=2.0V	-	-	190	ns
			V_{CC}=4.5V	-	-	38	ns
			V_{CC}=6.0V	-	-	33	ns
transition time	t_t	see Figure 6	V_{CC}=2.0V	-	-	75	ns
			V_{CC}=4.5V	-	-	15	ns
			V_{CC}=6.0V	-	-	13	ns
SN74HCT365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=4.5V	-	-	31	ns
$\overline{OE}$n to nY enable time	t_{en}	V_{CC}=4.5V; see Figure 7		-	-	44	ns
$\overline{OE}$n to nY disable time	t_{dis}	V_{CC}=4.5V; see Figure 7		-	-	44	ns
transition time	t_t	V_{CC}=4.5V; see Figure 6		-	-	15	ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_{en} is the same as t_{PZL} and t_{PZH}.

[3] t_{dis} is the sameast$_{PLZ}$ and t_{PHZ}.

[4] t_t is the sameast$_{THL}$ and t_{TLH}.

AC Characteristics 3

(T_{amb}=-40℃ to +125℃, GND=0V, C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=2.0V	-	-	145	ns
			V_{CC}=4.5V	-	-	29	ns
			V_{CC}=6.0V	-	-	25	ns
$\overline{OE}$n to nY enable time	t_{en}	see Figure 7	V_{CC}=2.0V	-	-	225	ns
			V_{CC}=4.5V	-	-	45	ns
			V_{CC}=6.0V	-	-	38	ns
$\overline{OE}$n to nY disable time	t_{dis}	see Figure 7	V_{CC}=2.0V	-	-	225	ns
			V_{CC}=4.5V	-	-	45	ns
			V_{CC}=6.0V	-	-	38	ns
transition time	t_t	see Figure 6	V_{CC}=2.0V	-	-	90	ns
			V_{CC}=4.5V	-	-	18	ns
			V_{CC}=6.0V	-	-	15	ns
SN74HCT365							
nA tonY propagation delay	t_{pd}	see Figure 6	V_{CC}=4.5V	-	-	38	ns
$\overline{OE}$n to nY enable time	t_{en}	V_{CC}=4.5V; see Figure 7		-	-	53	ns
$\overline{OE}$n to nY disable time	t_{dis}	V_{CC}=4.5V; see Figure 7		-	-	53	ns
transition time	t_t	V_{CC}=4.5V; see Figure 6		-	-	18	ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_{en} is the same as t_{PZL} and t_{PZH}.

[3] t_{dis} is the sameast$_{PLZ}$ and t_{PHZ}.

[4] t_t is the sameast$_{THL}$ and t_{TLH}.

Testing Circuit

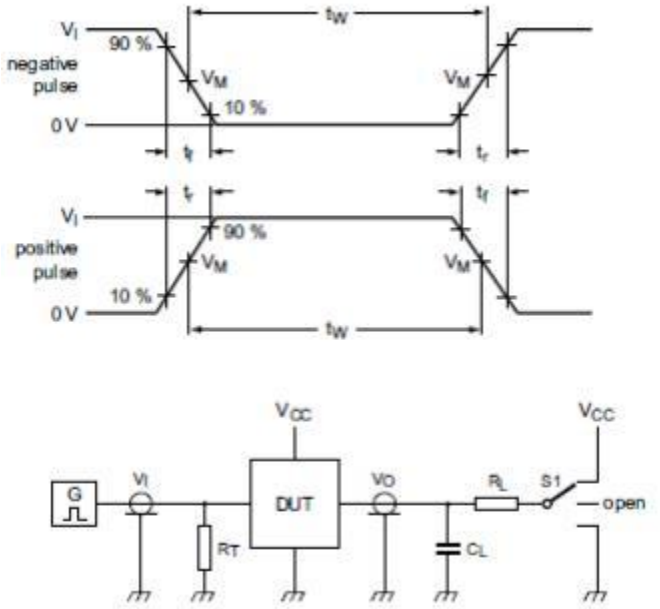


Figure 5. Test circuit for measuring switching times

Definitions for test circuit:

R_L=Load resistance.

C_L=Load capacitance including jig and probe capacitance.

R_T=Termination resistance should be equal to the output impedance Z_o of the pulse generator. S1=Test selection switch.

AC Testing Waveforms

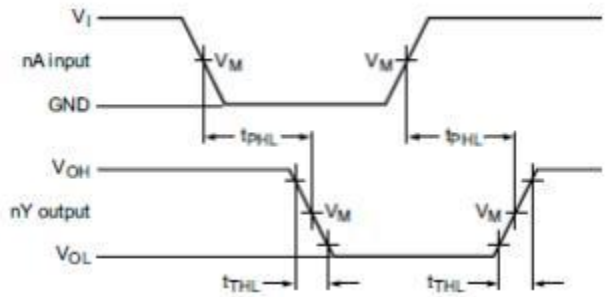


Figure 6. Input (nA) to output (nY) propagation delays and output transition times

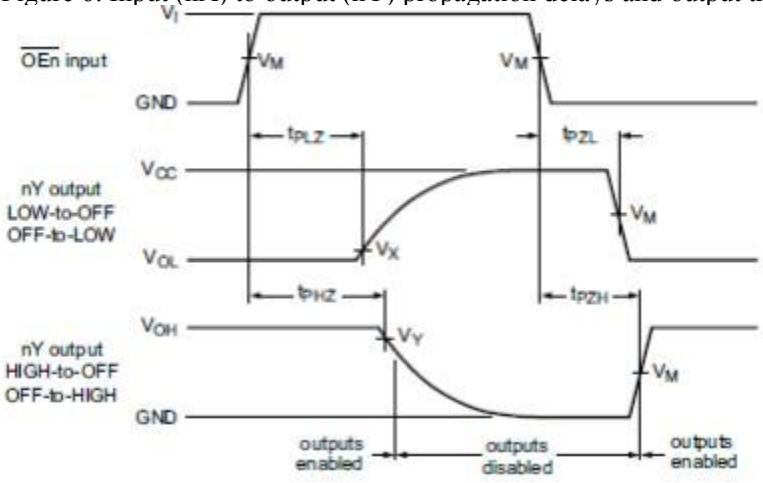


Figure 7. 3-state enable and disable times

Measurement Points

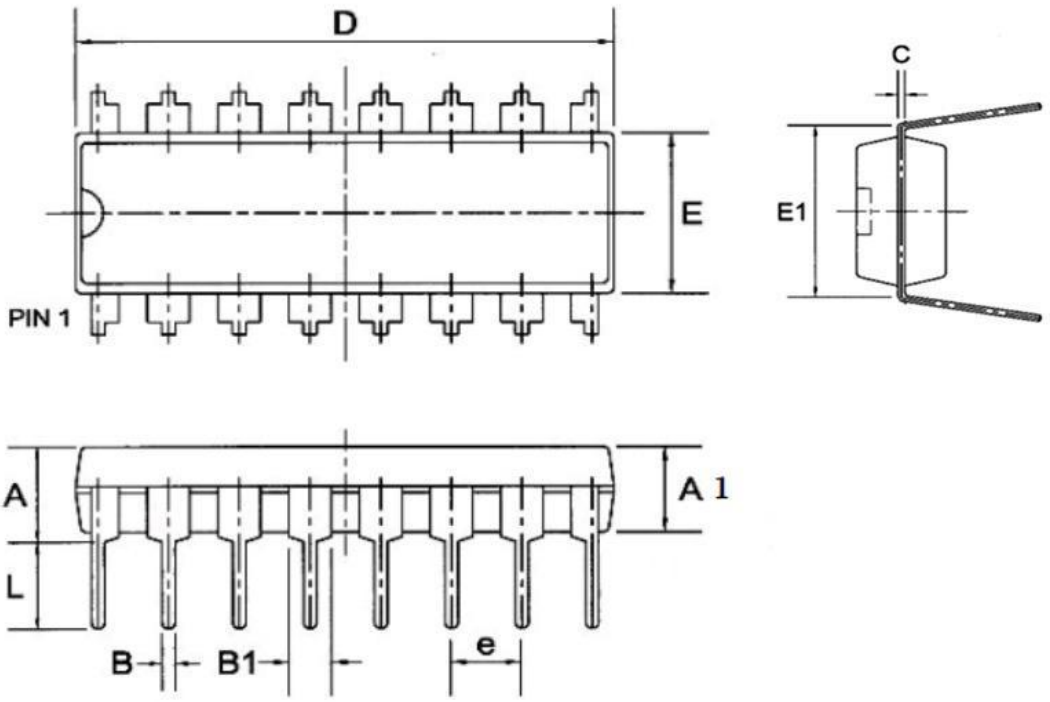
Type	Input	Output		
	V_M	V_M	V_X	V_Y
SN74HC365	$0.5\times V_{CC}$	$0.5\times V_{CC}$	$0.1\times V_{CC}$	$0.9\times V_{CC}$
SN74HCT365	1.3V	1.3V	$0.1\times V_{CC}$	$0.9\times V_{CC}$

Test Data

Type	Input		Load		S1 position		
	V_I	t_r ,t_f	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
SN74HC365	V_{CC}	6ns	15pF, 50pF	1kΩ	open	GND	V_{CC}
SN74HCT365	3V	6ns	15pF, 50pF	1kΩ	open	GND	V_{CC}

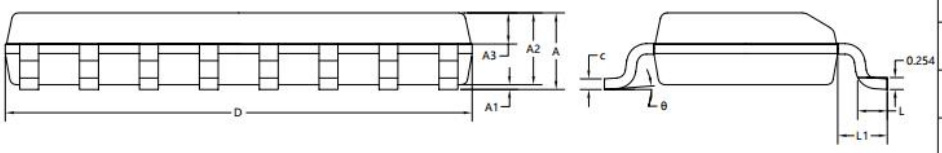
Package Information

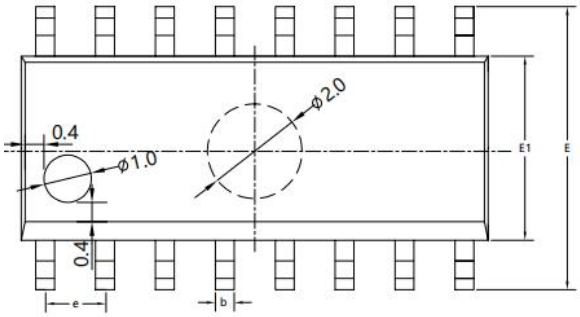
DIP16



Symbol	Dimensions in Millimeters		
	Min	Nom	Max
A	--	--	4.31
A1	3.15	3.30	3.65
B	--	0.50	--
B1	--	1.6	--
C	--	0.27	--
D	19.00	19.20	19.60
E	6.20	6.50	6.60
E1	--	8.0	--
e	--	2.3	--
L	3.00	3.20	3.60

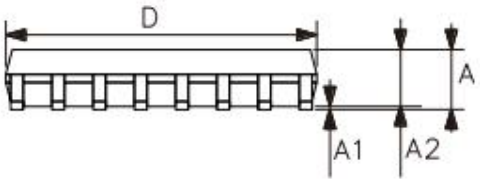
SOP16

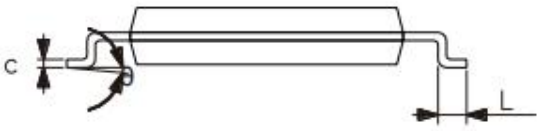


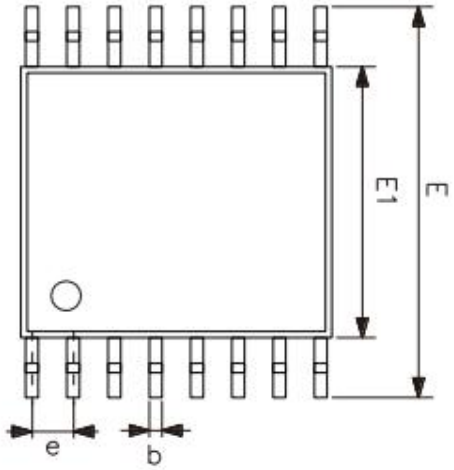


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	1.50	1.60	1.70
A1	0.10	0.15	0.25
A2	1.40	1.45	1.50
A3	0.60	0.65	0.70
b	0.30	0.40	0.50
c	0.15	0.20	0.25
D	9.80	9.90	10.00
E	5.80	6.00	6.20
E1	3.85	3.90	3.95
e	1.27BSC		
L	0.50	0.60	0.70
L1	1.05BSC		
θ	0°	4°	8°

TSSOP16







Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
θ	0°	8°

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